

N-channel 40 V 4.6 m Ω standard level MOSFET

Rev. 02 — 25 June 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

High efficiency due to low switching and conduction losses

1.3 Applications

- DC-to-DC convertors
- Load switching

1.4 Quick reference data

 Suitable for standard level gate drive sources

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- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	40	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>		-	-	100	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	148	W
Dynamic	characteristics						
Q_{GD}	gate-drain charge	$\label{eq:V_GS} \begin{array}{l} V_{GS} = 10 \text{ V}; \ I_D = 25 \text{ A}; \\ V_{DS} = 20 \text{ V}; \ see \ \underline{Figure \ 14}; \\ see \ \underline{Figure \ 15} \end{array}$		-	8.8	-	nC
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; see <u>Figure 13</u> ;	[1]	-	3.9	4.6	mΩ

[1] Measured 3 mm from package.

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		-
2	D	drain	mb	
3	S	source		
mb	D	mounting base; connected to drain		mbb076 S

SOT78 (TO-220AB; SC-46)

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN4R5-40PS	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

4. Limiting values

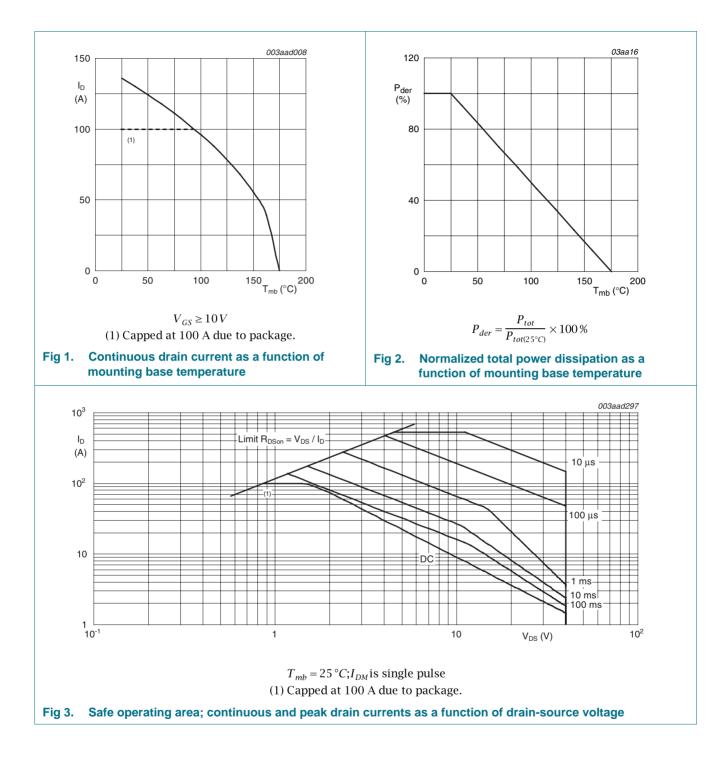
Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

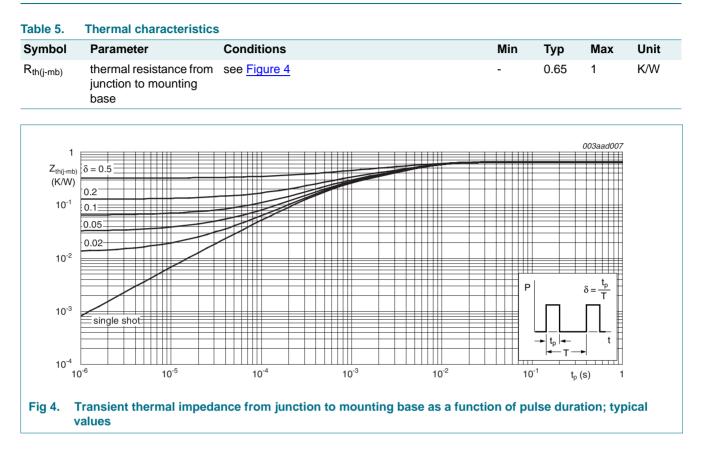
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	40	V
V _{DGR}	drain-gate voltage	T _j ≥ 25 °C; T _j ≤ 175 °C; R _{GS} = 20 kΩ	-	40	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	-	96	А
		$V_{GS} = 10 \text{ V}; \text{ T}_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 1}}{10000000000000000000000000000000000$	-	100	А
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3	-	545	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	148	W
T _{stg}	storage temperature		-55	175	°C
Тj	junction temperature		-55	175	°C
Source-dr	ain diode				
I _S	source current	T _{mb} = 25 °C	-	100	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	545	А
Avalanche	e ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 100 A; $V_{sup} \le 40$ V; unclamped; R_{GS} = 50 Ω	-	152	mJ

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PSMN4R5-40PS



5. Thermal characteristics



6. Characteristics

Table 6.Characteristics

Tested to JEDEC standards where applicable.

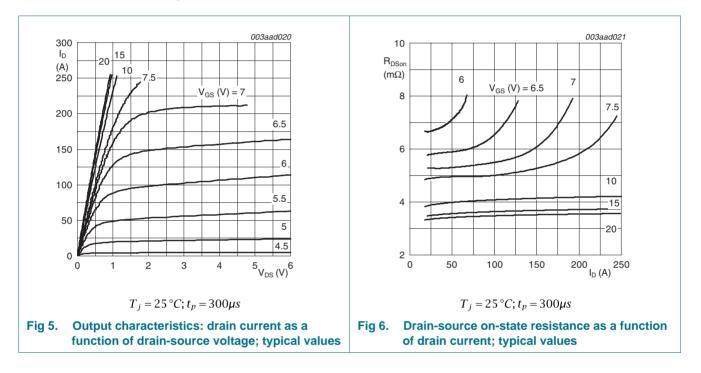
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$		36	-	-	V
breakdown voltage		$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$		40	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}; \text{ see}$ Figure 11; see Figure 12		-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C}; \text{ see}$ Figure 11; see Figure 12		1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; \text{ see}$ Figure 11; see Figure 12		2	3	4	V
I _{DSS}	drain leakage current	V_{DS} = 40 V; V_{GS} = 0 V; T_j = 25 °C		-	-	3	μA
		$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	60	μA
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
		V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 25 A; T_j = 100 °C; see Figure 13		-	-	6.7	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; see <u>Figure 13;</u>	[1]	-	3.9	4.6	mΩ
R _G	internal gate resistance (AC)	f = 1 MHz		-	0.97	-	Ω
Dynamic of	characteristics						
Q _{G(tot)}	total gate charge	$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$		-	35	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V}; \text{ see}$ Figure 14; see Figure 15		-	42.3	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V}; \text{ see}$		-	13.8	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	Figure 14; see Figure 15		-	7.9	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge			-	5.9	-	nC
Q _{GD}	gate-drain charge			-	8.8	-	nC
V _{GS(pl)}	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; \text{ see } \frac{\text{Figure } 14}{14}$		-	4.8	-	V
C _{iss}	input capacitance	V _{DS} = 12 V; V _{GS} = 0 V; f = 1 MHz;		-	2683	-	pF
C _{oss}	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{100}$		-	660	-	pF
C _{rss}	reverse transfer capacitance			-	290	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_{L} = 0.5 Ω ; V_{GS} = 10 V;		-	19	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \Omega$		-	23	-	ns
t _{d(off)}	turn-off delay time			-	30	-	ns
t _f	fall time			-	9	-	ns

Table 6. Characteristics ...continued

Tested to JEDEC standards where applicable.

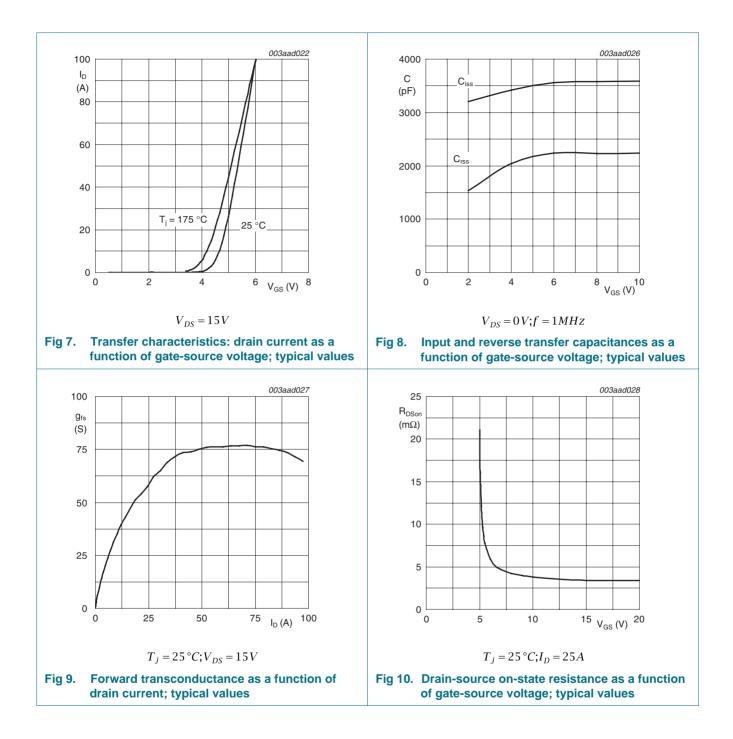
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-di	rain diode					
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 17</u>	-	0.75	1.2	V
t _{rr}	reverse recovery time	I_S = 50 A; dI_S/dt = -100 A/µs; V_{GS} = 0 V; V_{DS} = 20 V	-	40	-	ns
Qr	recovered charge	$ I_S = 50 \text{ A}; \ dI_S/dt = -100 \text{ A}/\mu s; \ V_{GS} = 0 \text{ V}; \\ V_{DS} = 20 \text{ V}; \ T_j = 25 \ ^\circ\text{C} $	-	33	-	nC

[1] Measured 3 mm from package.



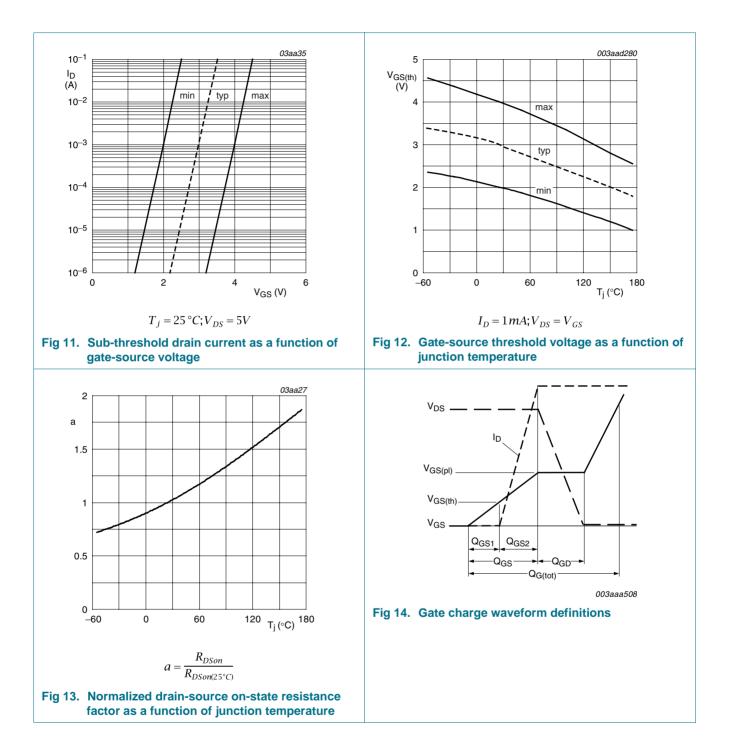
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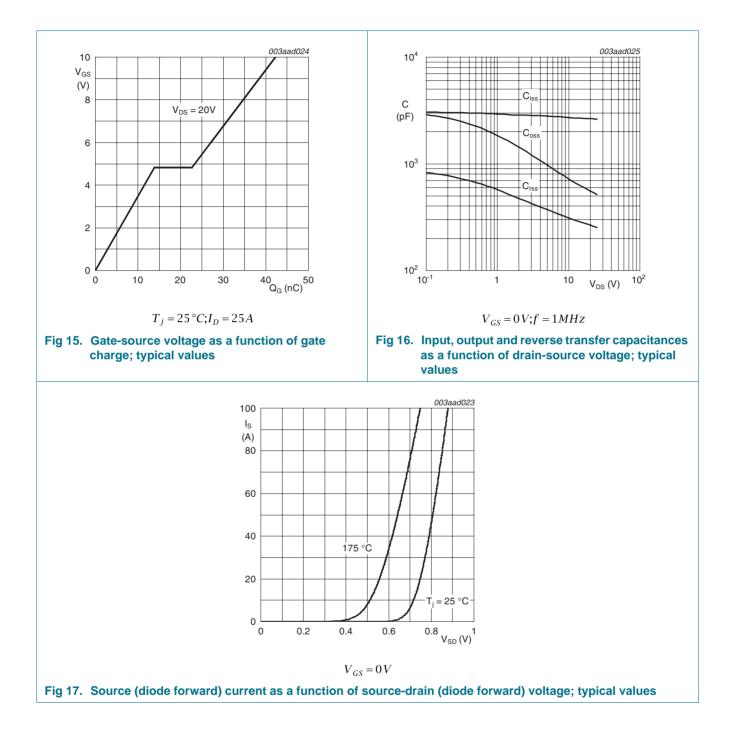
PSMN4R5-40PS



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PSMN4R5-40PS





N-channel 40 V 4.6 mΩ standard level MOSFET

7. Package outline

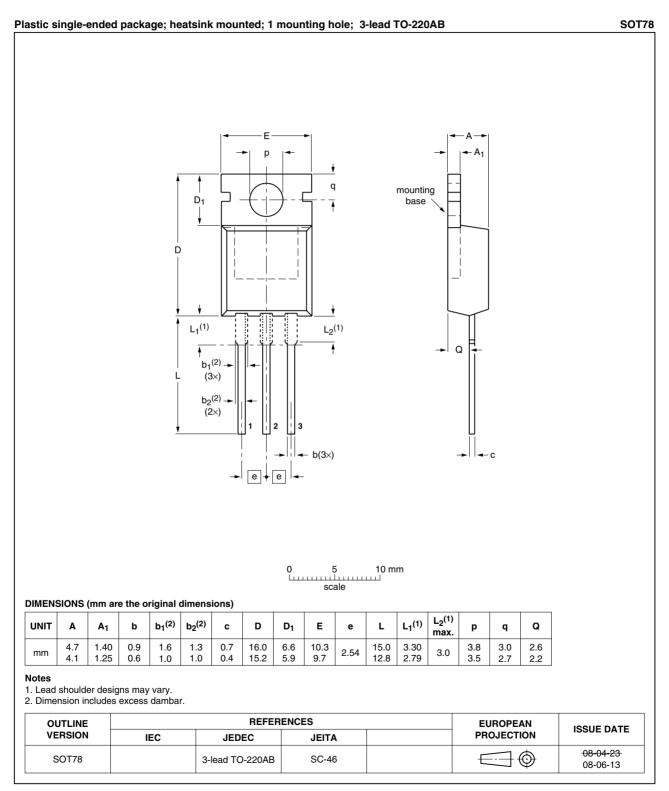


Fig 18. Package outline SOT78 (TO-220AB)

8. Revision history

Table 7.	Revision	history
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Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN4R5-40PS_2	20090625	Product data sheet	-	PSMN4R5-40PS_1
Modifications:	 Data sheet 	t status changed from obj	ective to product.	
	 Various ch 	anges to content.		
PSMN4R5-40PS_1	20090507	Objective data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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